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(12) **United States Design Patent**
Chong

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(54) **HEADPHONE**

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(**) Term: **15 Years**

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(51) **LOC (11) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
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2/209; 181/129, 130, 135; 379/430, 431;
381/380, 381, 74, 370, 374; 455/90.3,
455/575.1, 569.1

CPC H04R 1/1066; H04R 1/1016; H04R 5/033;
H04R 5/0335; H04R 25/00; H04R 1/1091
See application file for complete search history.

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(57) **CLAIM**

I claim the ornamental design for a headphone, as shown and described.

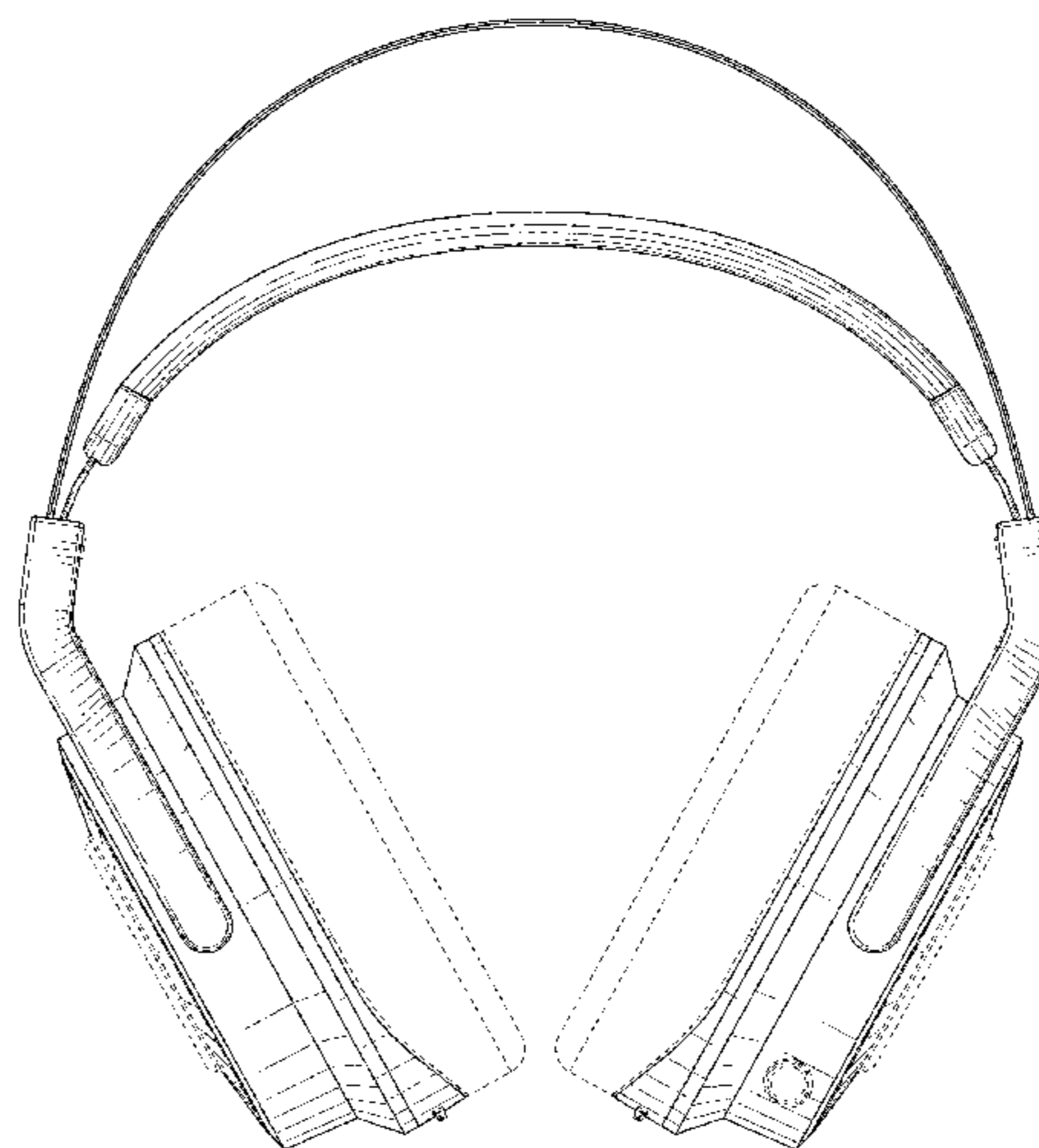
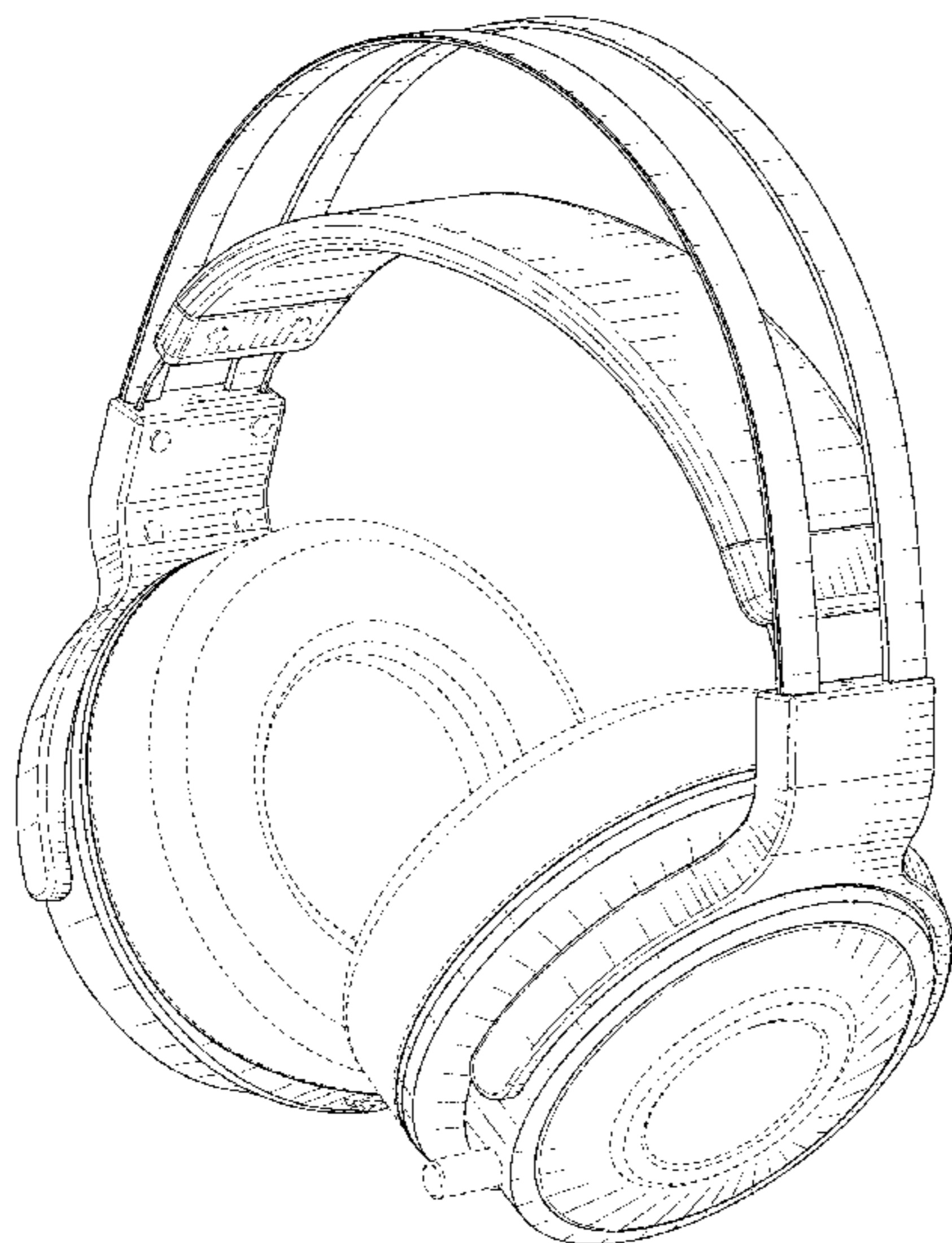
DESCRIPTION

FIG. 1 is a perspective view of an embodiment of a headphone, showing my new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a right side elevational view thereof;
FIG. 5 is a left side elevational view thereof;
FIG. 6 is a top plan view thereof; and,
FIG. 7 is a bottom plan view thereof.

Broken lines are for illustrating unclaimed portions of the headphone; the broken lines form no part of the claimed design.

Any change in scale between different views is not intended to limit the headphone to a particular size.

1 Claim, 6 Drawing Sheets



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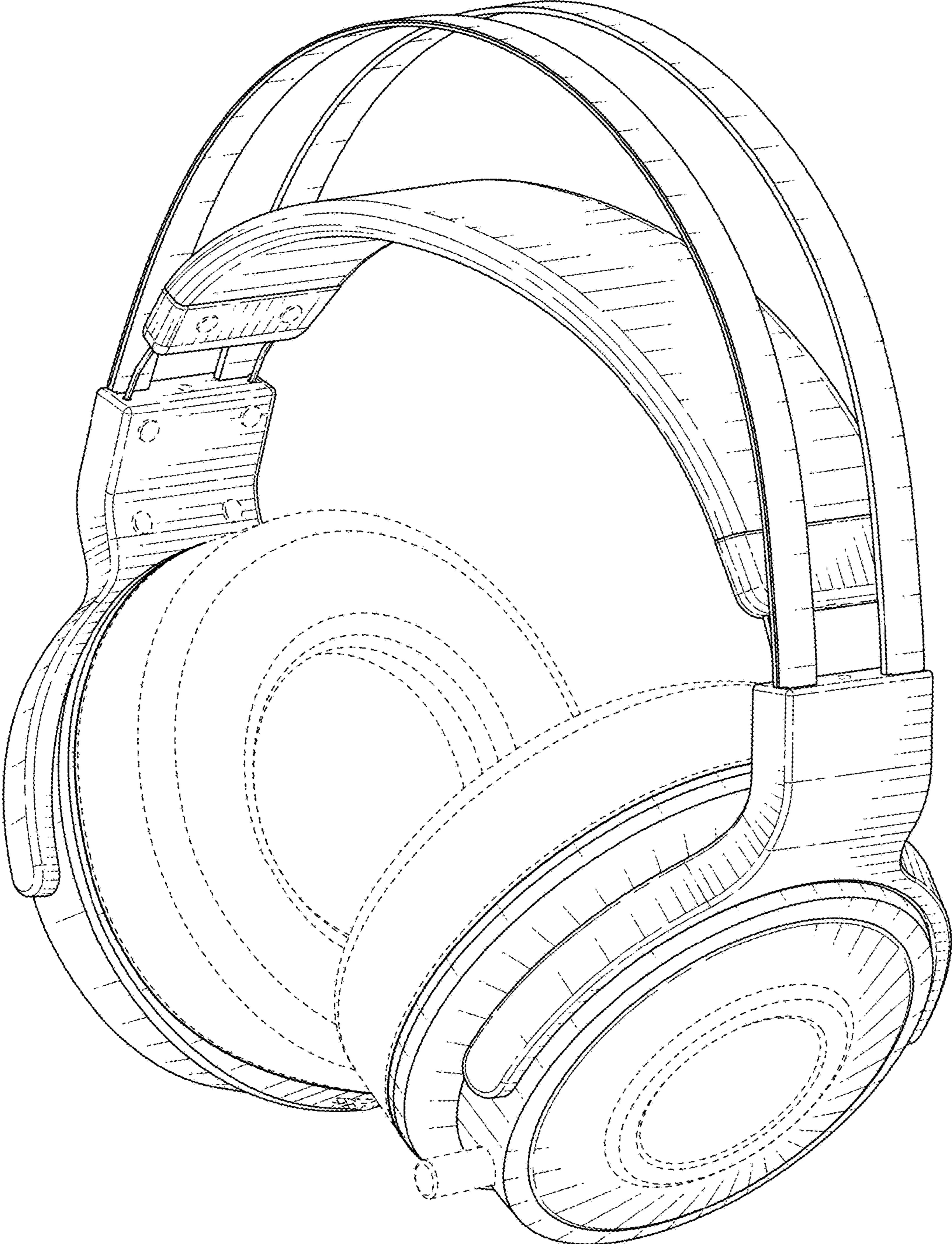


FIG. 1

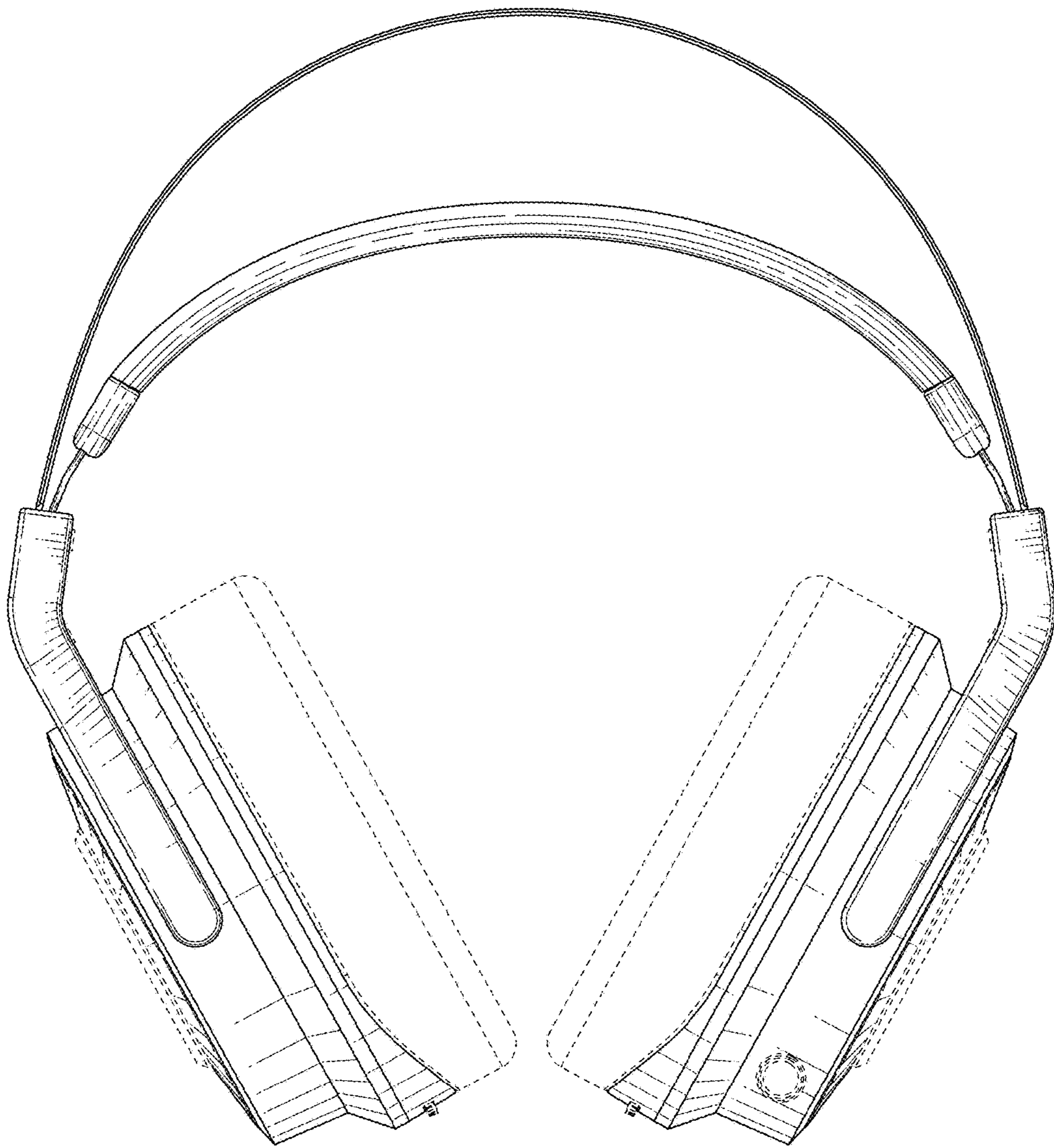


FIG. 2

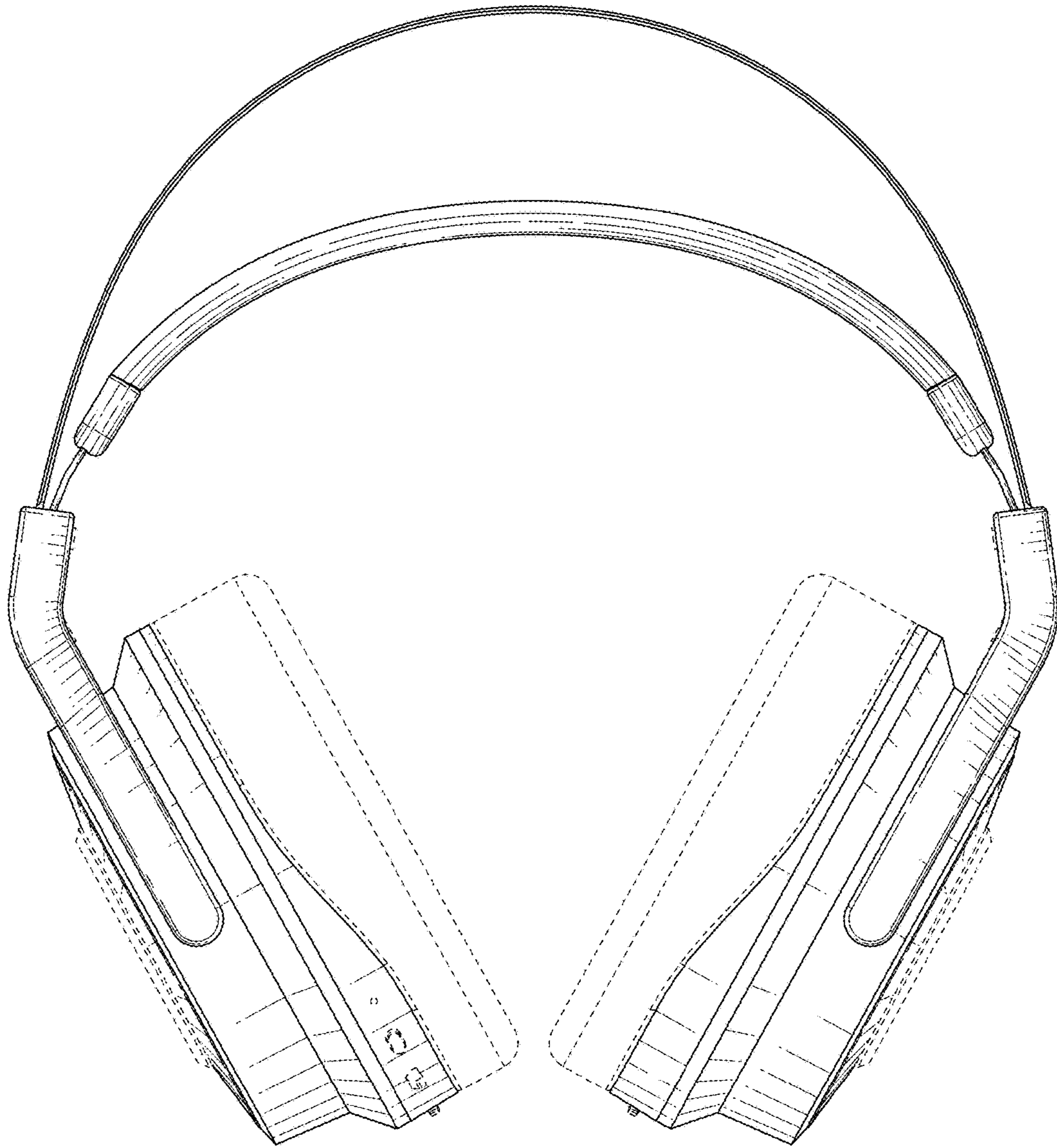


FIG. 3

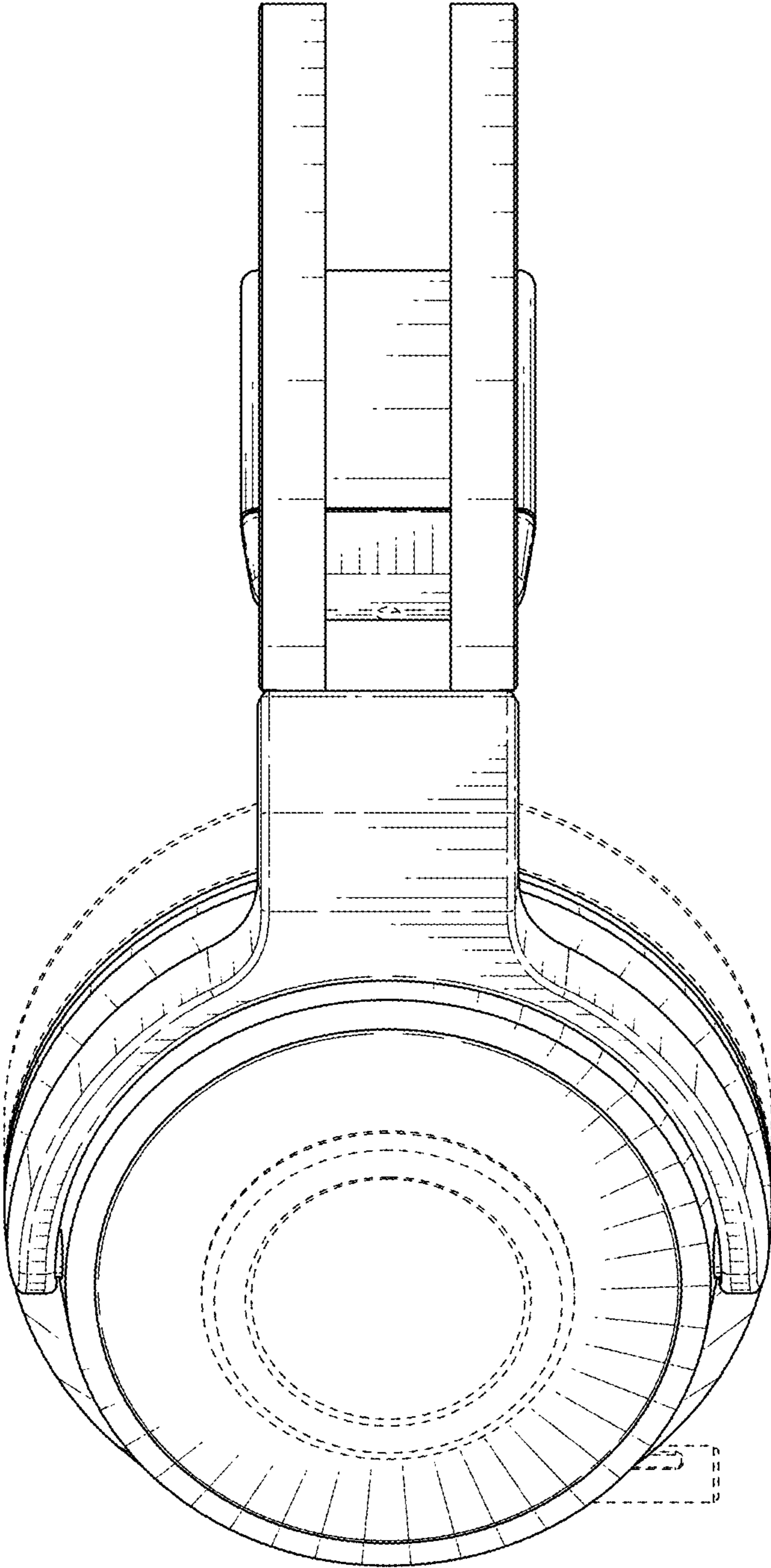


FIG. 4

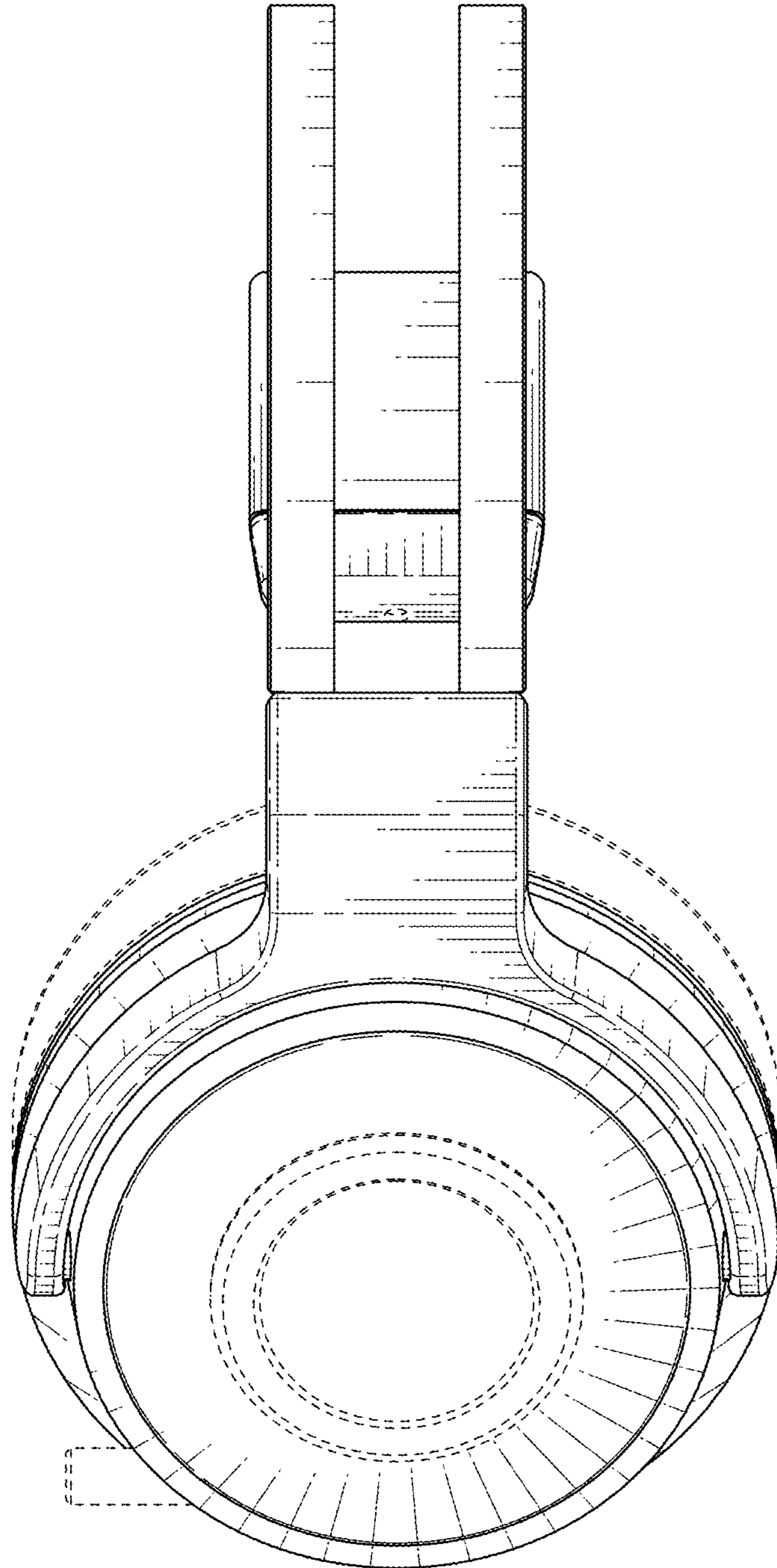


FIG. 5

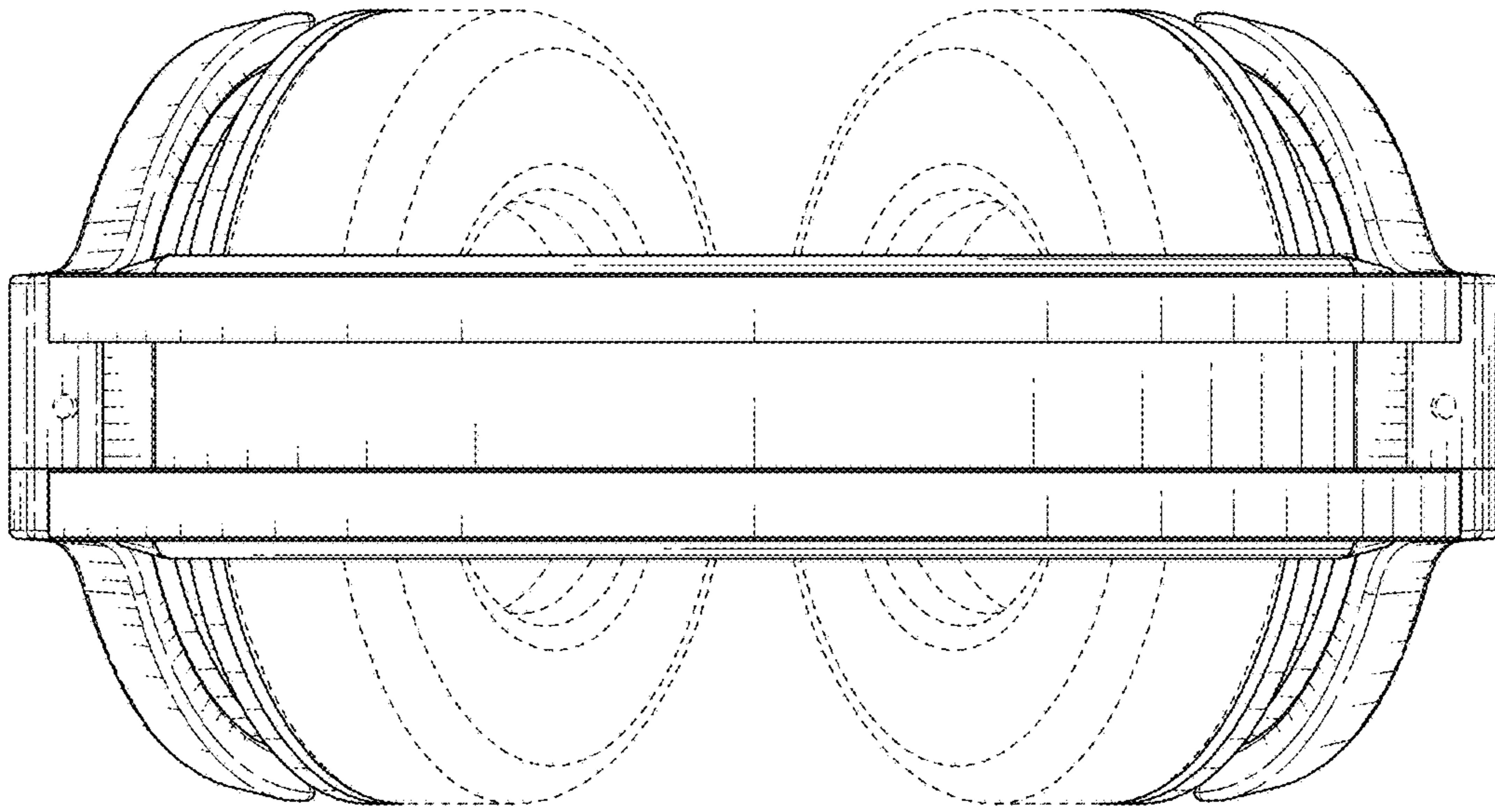


FIG. 6

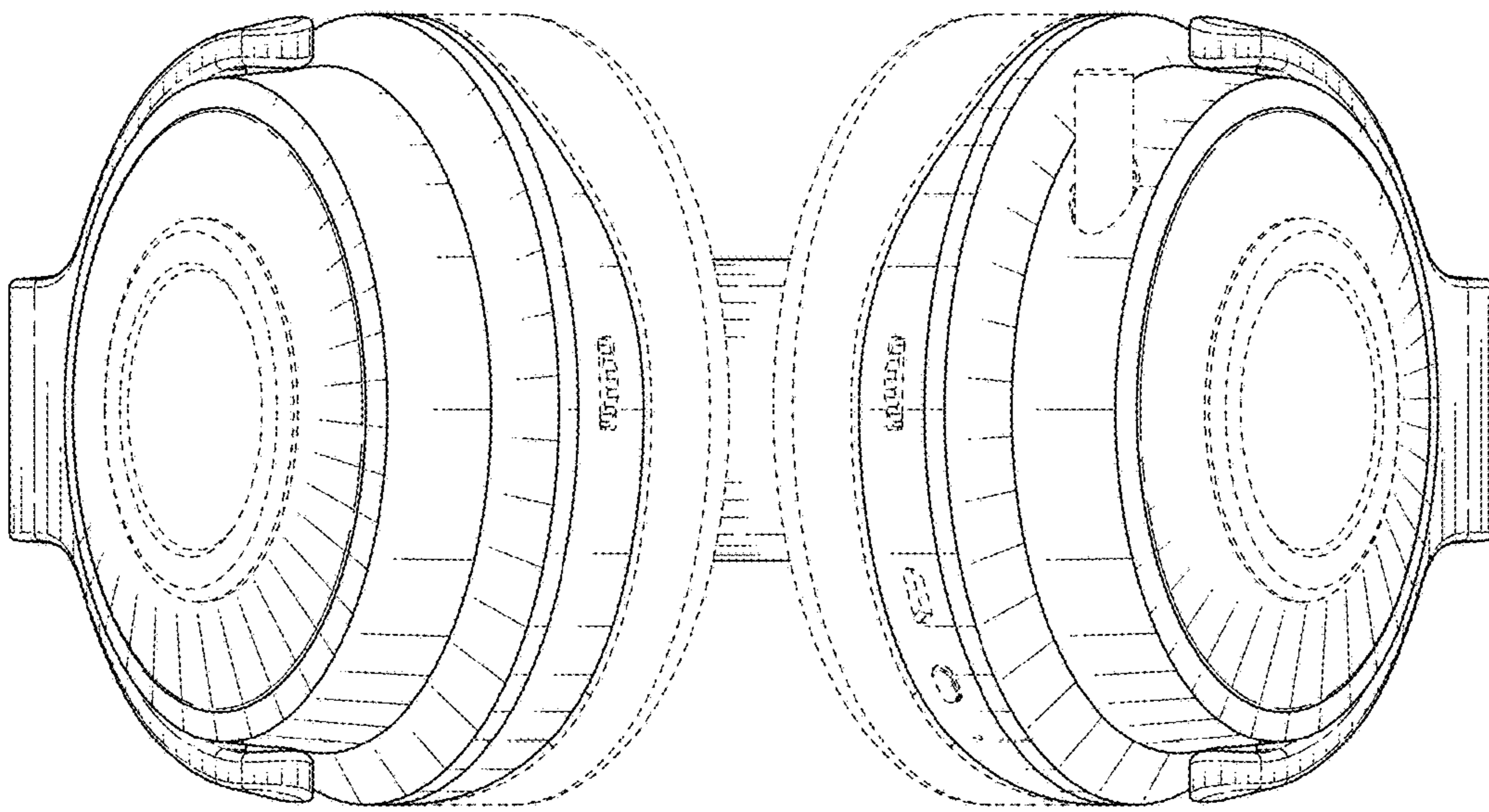


FIG. 7